TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSII)

TPC8203

Lithium Ion Battery Applications Portable Equipment Applications Notebook PCs

- Small footprint due to small and thin package
- Low drain-source ON resistance $: R_{DS} (ON) = 14 \text{ m}\Omega (typ.)$
- High forward transfer admittance $|Y_{fs}| = 8 S (typ.)$
- Low leakage current $: I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 30 \ V)$
- Enhancement-mode : $V_{th} = 0.8 \sim 2.5 V (V_{DS} = 10 V, I_D = 1 mA)$

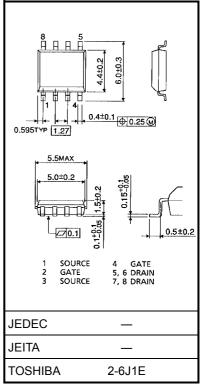
Maximum Ratings (Ta = 25°C)

Char	acteristics	Symbol	Rating	Unit	
Drain-source vo	Itage	V _{DSS}	30	V	
Drain-gate volta	ge (R _{GS} = 20 kΩ)	V _{DGR}	30	V	
Gate-source vol	tage	V _{GSS}	±20	V	
Drain current	D C (Note 1)	۱ _D	6	А	
Diamounent	Pulse (Note 1)	I _{DP}	24	~	
Drain power	Single-device operation (Note 3a)	P _{D (1)}	1.5		
dissipation (t = 10 s) (Note 2a)	Single-devece value at dual operation (Note 3b)	P _{D (2)}	1.0	W	
Drain power dissipation (t = 10 s) (Note 2b)	Single-device operation (Note 3a)	P _{D (1)}	0.75		
	Single-devece value at dual operation (Note 3b)	P _{D 2)}	0.45	W	
Single pulse ava	lanche energy (Note 4)	E _{AS}	46.8	mJ	
Avalanche curre	nt	I _{AR}	6	А	
Repetitive avalar (Note	nche energy e 2a, Note 3b, Note 5)	E _{AR}	0.10	mJ	
Channel tempera	ature	T _{ch}	150	°C	
Storage tempera	ture range	T _{stg}	-55~150	°C	

Note: For (Note 1), (Note 2a), (Note 2b), (Note 3a), (Note 3b), (Note 4) and (Note 5), please refer to the next page.

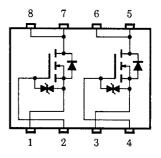
This transistor is an electrostatic sensitive device. Please handle with caution.





Weight: 0.080 g (typ.)

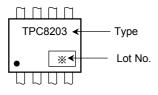
Circuit Configuration



Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	Single-device operation (Note 3a)	R _{th (ch-a) (1)}	83.3	
	Single-device value at dual operation (Note 3b)	R _{th (ch-a) (2)} 125		°C/W
Thermal resistance, channel to ambient	Single-device operation (Note 3a)	R _{th (ch-a) (1)}	167	0/11
(t = 10 s) (Note 2b)	Single-device value at dual operation (Note 3b)	R _{th (ch-a) (2)}	278	

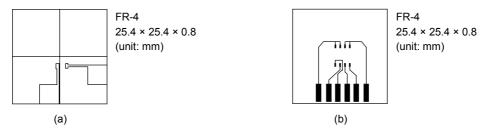
Marking



Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:

- a) Device mounted on a glass-epoxy board (a)
- b) Device mounted on a glass-epoxy board (b)

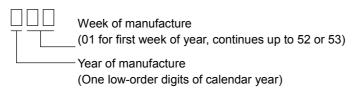


Note 3:

- a) The power dissipation and thermal resistance values are shown for a single device (During single-device operation, power is only applied to one device.)
- b) The power dissipation and thermal resistance values are shown for a single device (During dual operation, power is evenly applied to both devices.)

Note 4: V_{DD} = 24 V, T_{ch} = 25°C (Initial), L = 1.0 mH, R_G = 25 Ω , I_{AR} = 6.0 A

- Note 5: Repetitive rating: pulse width limited by maximum channel temperature
- Note 6: on lower left of the marking indicates Pin 1.
 - ※ Weekly code:(Three digits)



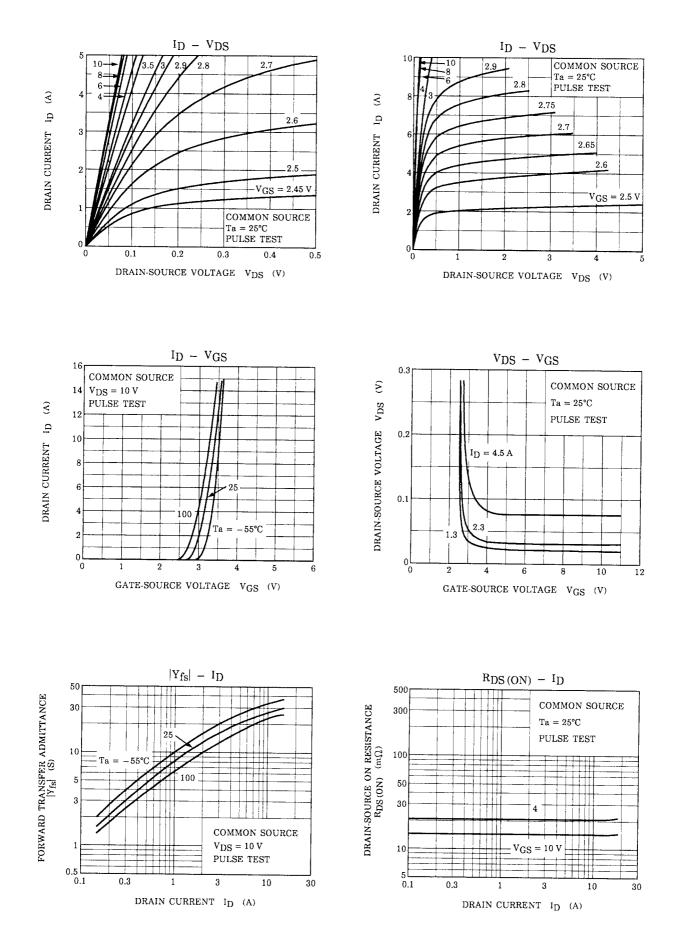
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	±10		μA	
Drain cut-OFF	current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	— — 10		μA	
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	30	_	—	V
	calcown voltage	V (BR) DSX	I_D = 10 mA, V_{GS} = -20 V	15	— 10		
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	-	2.5	V
Drain-source O	N rosistanco	R _{DS (ON)}	V _{GS} = 4 V, I _D = 3 A		22	32	mΩ
Dialit-Source O	IN TESISLATICE	R _{DS (ON)}	V _{GS} = 10 V, I _D = 3 A	_	14	21	11122
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 3 A	4	8	_	S
Input capacitant	ce	C _{iss}			1700	_	pF
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		260	_	
Output capacitance		C _{oss}			380	_	
Switching time	Rise time	tr	$V_{GS} \stackrel{10 \text{ V}}{_{0 \text{ V}}} \prod_{O \\ C \\ F \\ F$	_	10	_	
	Turn-ON time	t _{on}			20	_	
	Fall time	t _f		_	35	_	ns
	Turn-OFF time	t _{off}		_	120	_	
Total gate charge (Gate-source plus gate-drain)		Qg			40	_	
Gate-source charge		Q _{gs}	V _{DD} ≈ 24 V, V _{GS} = 10 V, I _D = 6 A		28	—	nC
Gate-drain ("miller") charge		Q _{gd}		_	12	—	

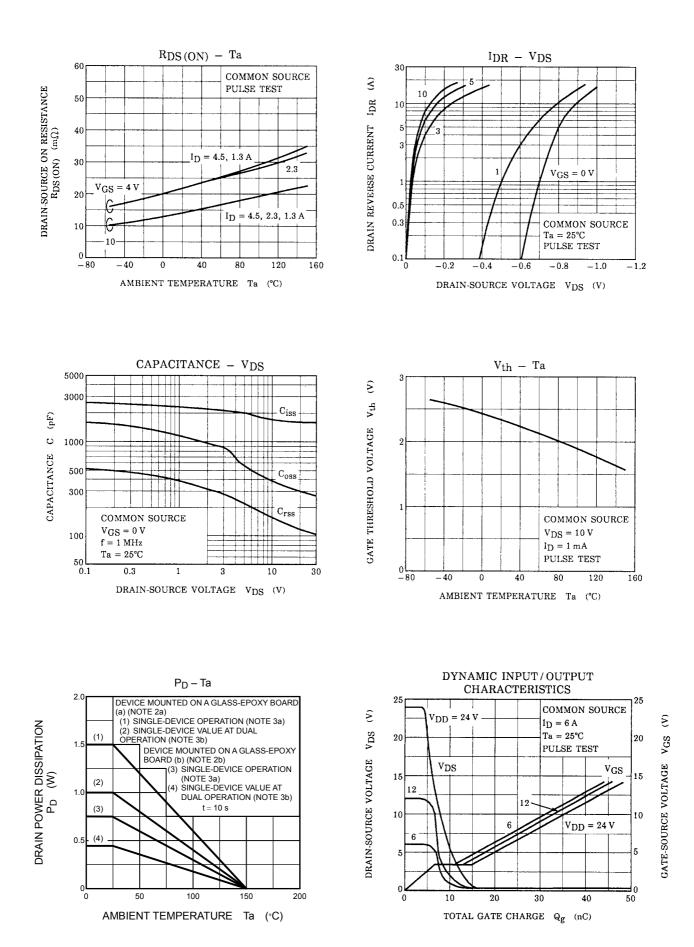
Source–Drain Ratings and Characteristics (Ta = 25°C)

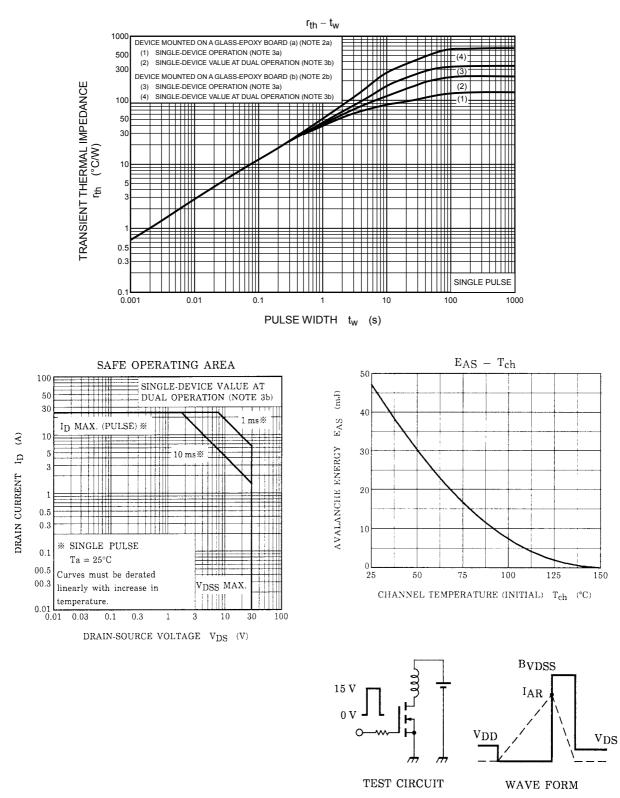
Charact	teristics	Symbol	Test Condition	Min	Тур. Мах		Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	—	_	_	24	А
Forward voltage	(diode)	V _{DSF}	I _{DR} = 6 A, V _{GS} = 0 V	_	—	-1.2	V

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 $T_{ch}=25^{\circ}C$ (Initial) $\begin{array}{l} T_{ch} = 25^{\circ}C \ (Initial) \\ Peak \ IAR = 4.5 \ A, \ R_G = 25 \ \Omega \quad EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \ (\frac{BVDSS}{BVDSS - V_{DD}}) \end{array}$

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